# Presettable Divide-By-N Counter

The MC14018B contains five Johnson counter stages which are asynchronously presettable and resettable. The counters are synchronous, and increment on the positive going edge of the clock.

Presetting is accomplished by a logic 1 on the preset enable input. Data on the Jam inputs will then be transferred to their respective  $\overline{Q}$  outputs (inverted). A logic 1 on the reset input will cause all  $\overline{Q}$  outputs to go to a logic 1 state.

Division by any number from 2 to 10 can be accomplished by connecting appropriate  $\overline{Q}$  outputs to the data input, as shown in the Function Selection table. Anti–lock gating is included in the MC14018B to assure proper counting sequence.

#### **Features**

- Fully Static Operation
- Schmitt Trigger on Clock Input
- Capable of Driving Two Low-Power TTL Loads or One Low-Power Schottky TTL Load Over the Rated Temperature Range
- Pin-for-Pin Replacement for CD4018B
- Pb-Free Packages are Available\*

#### MAXIMUM RATINGS (Voltages Referenced to V<sub>SS</sub>)

Symbol	Parameter	Value	Unit
$V_{DD}$	DC Supply Voltage Range	-0.5 to +18.0	V
V <sub>in</sub> , V <sub>out</sub>	Input or Output Voltage Range (DC or Transient)	-0.5 to V <sub>DD</sub> + 0.5	V
I <sub>in</sub> , I <sub>out</sub>	Input or Output Current (DC or Transient) per Pin	±10	mA
P <sub>D</sub>	Power Dissipation, per Package (Note 1)	500	mW
T <sub>A</sub>	Ambient Temperature Range	-55 to +125	°C
T <sub>stg</sub>	Storage Temperature Range	-65 to +150	°C
TL	Lead Temperature (8–Second Soldering)	260	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

1. Temperature Derating:

Plastic "P and D/DW" Packages: - 7.0 mW/°C From 65°C To 125°C

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high–impedance circuit. For proper operation,  $V_{in}$  and  $V_{out}$  should be constrained to the range  $V_{SS} \leq (V_{in} \mbox{ or } V_{out}) \leq V_{DD}.$ 

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either  $V_{SS}$  or  $V_{DD}$ ). Unused outputs must be left open.

\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



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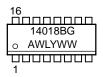
MARKING DIAGRAMS



PDIP-16 P SUFFIX CASE 648 16<mark>ኩሉሉሉሉሉሉ</mark> MC14018BCP o AWLYYWWG 1 ሁሁ ሁሁ ሁሁ ሁ



SOIC-16 D SUFFIX CASE 751B



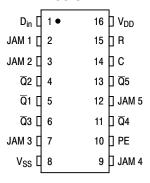
A = Assembly Location

 $\begin{array}{ll} \text{WL, L} &= \text{Wafer Lot} \\ \text{YY, Y} &= \text{Year} \\ \text{WW, W} &= \text{Work Week} \\ \text{G} &= \text{Pb-Free Indicator} \end{array}$ 

#### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

### **PIN ASSIGNMENT**



### **FUNCTIONAL TRUTH TABLE**

Clock	Reset	Preset Enable	Jam Input	Qn
/	0	0	Х	Qn
	0	0	Х	$\overline{D}_n^*$
X	0	1	0	1
X	0	1	1	0
X	1	Х	Х	1

<sup>\*</sup>D<sub>n</sub> is the Data input for that stage. Stage 1 has Data brought out to Pin 1.

### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>	
MC14018BCP	PDIP-16	500 Units / Rail	
MC14018BCPG	PDIP-16 (Pb-Free)	500 Units / Rail	
MC14018BD	SOIC-16	48 Units / Rail	
MC14018BDG	SOIC-16 (Pb-Free)	48 Units / Rail	
MC14018BDR2	SOIC-16	2500 Units / Tape & Reel	
MC14018BDR2G	SOIC-16 (Pb-Free)	2500 Units / Tape & Reel	

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

### **ELECTRICAL CHARACTERISTICS** (Voltages Referenced to V<sub>SS</sub>)

				- 5	5°C		25°C		125	5°C	
Characteristic		Symbol	V <sub>DD</sub> Vdc	Min	Max	Min	Typ (Note 2)	Max	Min	Max	Unit
Output Voltage V <sub>in</sub> = V <sub>DD</sub> or 0	"0" Level	V <sub>OL</sub>	5.0 10 15	_ _ _	0.05 0.05 0.05	_ _ _	0 0 0	0.05 0.05 0.05	_ _ _	0.05 0.05 0.05	Vdc
$V_{in} = 0$ or $V_{DD}$	"1" Level	V <sub>OH</sub>	5.0 10 15	4.95 9.95 14.95	_ _ _	4.95 9.95 14.95	5.0 10 15	_ _ _	4.95 9.95 14.95	_ _ _	Vdc
Input Voltage $(V_O = 4.5 \text{ or } 0.5 \text{ Vdc})$ $(V_O = 9.0 \text{ or } 1.0 \text{ Vdc})$ $(V_O = 13.5 \text{ or } 1.5 \text{ Vdc})$	"0" Level	V <sub>IL</sub>	5.0 10 15		1.5 3.0 4.0		2.25 4.50 6.75	1.5 3.0 4.0		1.5 3.0 4.0	Vdc
$(V_O = 0.5 \text{ or } 4.5 \text{ Vdc})$ $(V_O = 1.0 \text{ or } 9.0 \text{ Vdc})$ $(V_O = 1.5 \text{ or } 13.5 \text{ Vdc})$	"1" Level	V <sub>IH</sub>	5.0 10 15	3.5 7.0 11	_ _ _	3.5 7.0 11	2.75 5.50 8.25	_ _ _	3.5 7.0 11	_ _ _	Vdc
Output Drive Current (V <sub>OH</sub> = 2.5 Vdc) (V <sub>OH</sub> = 4.6 Vdc) (V <sub>OH</sub> = 9.5 Vdc) (V <sub>OH</sub> = 13.5 Vdc)	Source	I <sub>OH</sub>	5.0 5.0 10 15	- 3.0 - 0.64 - 1.6 - 4.2	_ _ _ _	- 2.4 - 0.51 - 1.3 - 3.4	- 4.2 - 0.88 - 2.25 - 8.8	_ _ _ _	- 1.7 - 0.36 - 0.9 - 2.4	_ _ _ _	mAdc
$(V_{OL} = 0.4 \text{ Vdc})$ $(V_{OL} = 0.5 \text{ Vdc})$ $(V_{OL} = 1.5 \text{ Vdc})$	Sink	I <sub>OL</sub>	5.0 10 15	0.64 1.6 4.2	_ _ _	0.51 1.3 3.4	0.88 2.25 8.8	_ _ _	0.36 0.9 2.4	_ _ _	mAdc
Input Current		I <sub>in</sub>	15	_	± 0.1	_	±0.00001	± 0.1	_	± 1.0	μAdc
Input Capacitance (V <sub>in</sub> = 0)		C <sub>in</sub>	_	_	_	_	5.0	7.5	_	_	pF
Quiescent Current (Per Package)		I <sub>DD</sub>	5.0 10 15	_ _ _	5.0 10 20	_ _ _	0.005 0.010 0.015	5.0 10 20	_ _ _	150 300 600	μAdc
Total Supply Current (Note (Dynamic plus Quiesce Per Package) (C <sub>L</sub> = 50 pF on all outp buffers switching)	ent,	I <sub>T</sub>	5.0 10 15			$I_T = (0$	).3 μΑ/kHz) f ).7 μΑ/kHz) f l.0 μΑ/kHz) f	+ I <sub>DD</sub>			μAdc

Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.
 The formulas given are for the typical characteristics only at 25°C.
 To calculate total supply current at loads other than 50 pF:

$$I_T(C_L) = I_T(50 \text{ pF}) + (C_L - 50) \text{ Vfk}$$

where:  $I_T$  is in  $\mu A$  (per package),  $C_L$  in pF,  $V = (V_{DD} - V_{SS})$  in volts, f in kHz is input frequency, and k = 0.001.

### **SWITCHING CHARACTERISTICS** (Note 5) ( $C_L = 50 \text{ pF}, T_A = 25^{\circ}C$ )

		.,		All Types			
Characteristic	Symbol	V <sub>DD</sub> Vdc	Min	Typ (Note 6)	Max	Unit	
Output Rise and Fall Time $t_{TLH}, t_{THL} = (1.35 \text{ ns/pF}) \text{ C}_L + 32 \text{ ns}$ $t_{TLH}, t_{THL} = (0.6 \text{ ns/pF}) \text{ C}_L + 20 \text{ ns}$ $t_{TLH}, t_{THL} = (0.4 \text{ ns/pF}) \text{ C}_L + 20 \text{ ns}$	t <sub>TLH</sub> , t <sub>THL</sub>	5.0 10 15	_ _ _	100 50 40	200 100 80	ns	
Propagation Delay Time Clock to $\overline{Q}$ $t_{PLH}$ , $t_{PHL}$ = (0.90 ns/pF) $C_L$ + 265 ns $t_{PLH}$ , $t_{PHL}$ = (0.36 ns/pF) $C_L$ + 102 ns $t_{PLH}$ , $t_{PHL}$ = (0.26 ns/pF) $C_L$ + 72 ns	t <sub>PLH</sub> , t <sub>PHL</sub>	5.0 10 15	_ _ _	310 120 85	620 240 170	ns	
Reset to $\overline{Q}$ $t_{PLH} = (0.90 \text{ ns/pF}) C_L + 325 \text{ ns}$ $t_{PLH} = (0.36 \text{ ns/pF}) C_L + 132 \text{ ns}$ $t_{PLH} = (0.26 \text{ ns/pF}) C_L + 81 \text{ ns}$		5.0 10 15	_ _ _	370 150 100	740 300 200	ns	
Preset Enable to $\overline{Q}$ $t_{PLH}$ , $t_{PHL}$ = (0.90 ns/pF) $C_L$ + 325 ns $t_{PLH}$ , $t_{PHL}$ = (0.36 ns/pF) $C_L$ + 132 ns $t_{PLH}$ , $t_{PHL}$ = (0.26 ns/pF) $C_L$ + 81 ns		5.0 10 15	  -  -	370 150 100	740 300 200	ns	
Setup Time Data (Pin 1) to Clock	t <sub>su</sub>	5.0 10 15	200 100 80	0 0 0	_ _ _	ns	
Jam Inputs to Preset Enable		5.0 10 15	200 100 80	0 0 0	_ _ _	ns	
Data (Jam Inputs)–to–Preset Enable Hold Time	t <sub>h</sub>	5.0 10 15	540 500 480	270 250 240	_ _ _	ns	
Clock Pulse Width	t <sub>WH</sub>	5.0 10 15	400 200 160	200 100 80	_ _ _	ns	
Reset or Preset Enable Pulse Width	t <sub>WH</sub>	5.0 10 15	290 130 110	145 65 55	_ _ _	ns	
Clock Rise and Fall Time	t <sub>TLH</sub> , t <sub>THL</sub>	5.0 10 15		No Limit		ns	
Clock Pulse Frequency	f <sub>cl</sub>	5.0 10 15	_ _ _	2.5 6.5 8.0	1.25 3.25 4.0	MHz	

- 5. The formulas given are for the typical characteristics only at 25°C.6. Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.

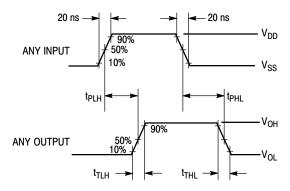
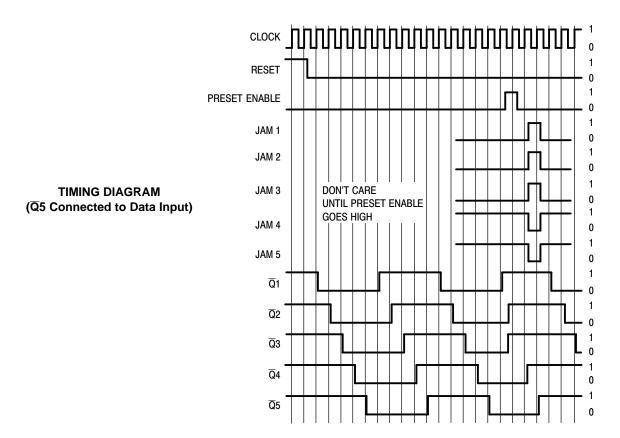


Figure 1. Switching Time Waveforms

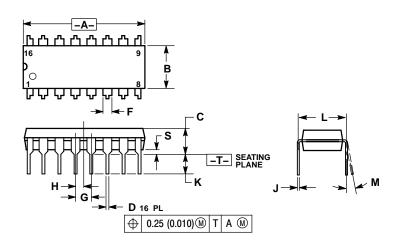


### **FUNCTION SELECTION**

Counter Mode	Connect Data Input (Pin 1) to:	Comments						
Divide by 10 Divide by 8 Divide by 6 Divide by 4 Divide by 2	Q5 Q4 Q3 Q2 Q1	No external components needed.			LO	GIC DIAGE	RAM	
Divide by 9 Divide by 7 Divide by 5 Divide by 3	$ \overline{Q}5 \bullet \overline{Q}4 $ $ \overline{Q}4 \bullet \overline{Q}3 $ $ \overline{Q}3 \bullet \overline{Q}2 $ $ \overline{Q}2 \bullet \overline{Q}1 $	Gate package needed to provide AND function. Counter Skips all 1's state		JAM 1	JAM 2	JAM 3	JAM 4	JAM 5
	(		CLOCK SHAPER		J S Q I		D S Q	, sol
	ı	RESET 15 0		C R P	C Q R P	C R P	C R P	C R P
	PRESET E	NABLE 10 0						
			V <sub>DD</sub> = PIN 16 V <sub>SS</sub> = PIN 8	5 0		7 \sum_6	11	13 I3 Q4 Q5

### **PACKAGE DIMENSIONS**

PDIP-16 **P SUFFIX** PLASTIC DIP PACKAGE CASE 648-08 ISSUE T

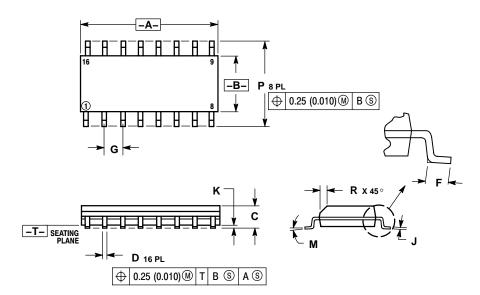


- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.
  3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
  4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
  5. ROUNDED CORNERS OPTIONAL.

	INC	HES	MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.740	0.770	18.80	19.55
В	0.250	0.270	6.35	6.85
С	0.145	0.175	3.69	4.44
D	0.015	0.021	0.39	0.53
F	0.040	0.70	1.02	1.77
G	0.100	BSC	2.54	BSC
Н	0.050	BSC	1.27	BSC
J	0.008	0.015	0.21	0.38
K	0.110	0.130	2.80	3.30
L	0.295	0.305	7.50	7.74
M	0°	10 °	0°	10 °
S	0.020	0.040	0.51	1.01

### **PACKAGE DIMENSIONS**

SOIC-16 **D SUFFIX** PLASTIC SOIC PACKAGE CASE 751B-05 **ISSUE J** 



#### NOTES:

- NOTES:

  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: MILLIMETER.
  3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
  4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
  5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIN	IETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	9.80	10.00	0.386	0.393
В	3.80	4.00	0.150	0.157
С	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27	BSC	0.050 BSC	
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
Р	5.80	6.20	0.229	0.244
R	0.25	0.50	0.010	0.019

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